



深圳市一众显示科技有限公司

SHEN ZHEN TEAM SOURCE DISPLAY TECH. CO, LTD.

TFT-LCD Module Specification

Module NO.: TST3972532

Version: V1.0

APPROVAL FOR SPECIFICATION

APPROVAL FOR SAMPLE

For Customer' s Acceptance:	
Approved by	Comment

Team Source Display:		
Presented by	Reviewed by	Organized by

Version No.	Date	Content	Remark
V1.0	2018-4-18	Initial Release	

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1 General Characteristics

ITEM	Specification	Unit
LCD Type	a-Si TFT, Transmissive, Normally white, TN	-
LCD Size	3.97	inch
Resolution (W x H)	480 x (RGB) × 800	pixel
LCM size	57.14(W) x 96.85(H) x 2.2(D)	mm
Active Area	51.84 (W) x 86.4 (H)	mm
Dot Pitch	0.108(H)x0.108(V)	mm
Viewing Direction	12 o'clock	-
Gray Scale Inversion Direction	-	-
Viewing Angle	Top:70, Bottom:60; Left/ Right:70	deg.
Color Depth	16.7M	-
Pixel Arrangement	RGB-stripe	-
Backlight Type	8 LEDs, 40mA	-
Surface Luminance	400	cd/m ²
Surface Treatment	Anti-Glare	-
Driver IC	ST7701S	-
Interface Type	RGB	-
Input Voltage	2.8(TYP)	V
With/Without TP	Without	-
Weight	TBD	g

Note 1: RoHS compliant

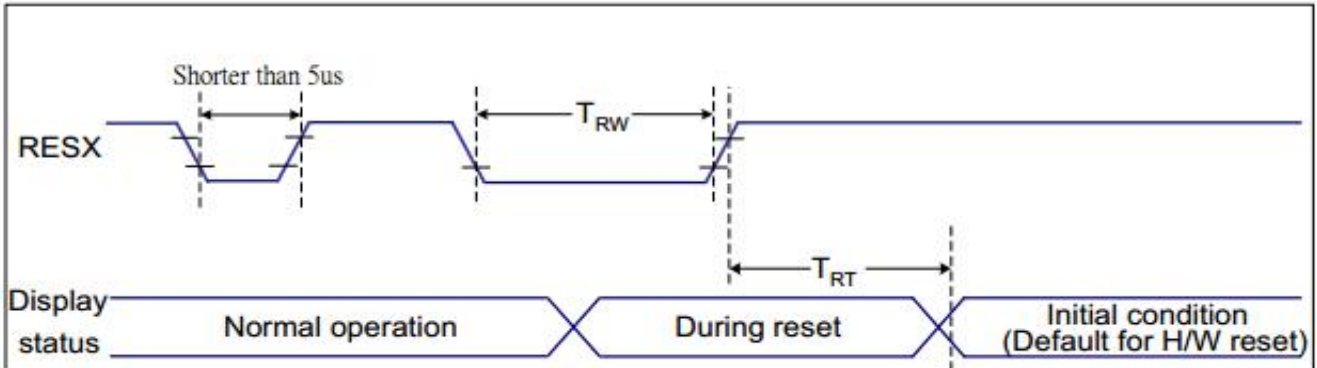
Note 2: LCM weight tolerance: ± 5%.

3 Interface description

引脚(PIN)	符号(symbol)	描述(description)
1	LEDA	Backlight A Aothod input pin.
2	LEDK	Backlight K Cathode input pin.
3	IOVCC	Interface pin Power supply +1.8V~+2.8V
4	NC	
5	GND	System Ground. (0V)
6	RESET	Reset input signal
7	TE	Tearing Effect output signal
8	VCI	Power supply +2.8V
9	VCI	Power supply +2.8V
10	GND	System Ground. (0V)
11	GND	System Ground. (0V)
12	TDP0	MIPI data0 positive signal line
13	TDN0	MIPI data0 negative signal line
14	GND	System Ground. (0V)
15	NC	
16	NC	
17	GND	System Ground. (0V)
18	TDN1	MIPI data1 negative signal line
19	TDP1	MIPI data1 positive signal line
20	GND	System Ground. (0V)
21	TCN	MIPI clock signal line
22	TCP	MIPI clock signal line
23	GND	System Ground. (0V)
24	NC	
25	NC	

4 LCM Interface Timing

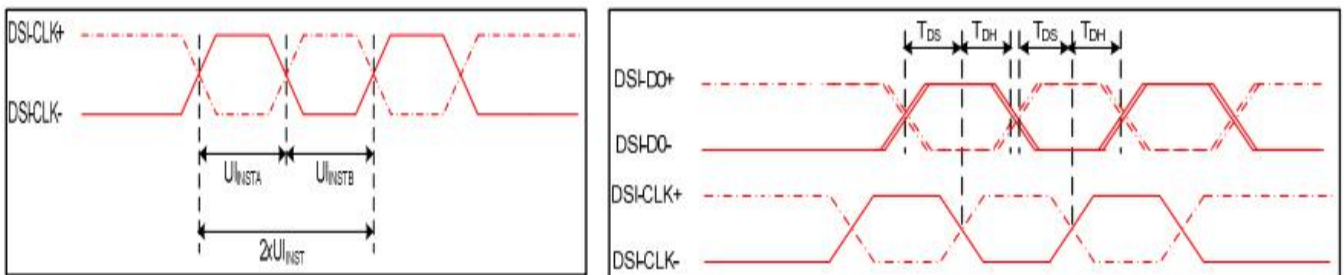
4.1 Reset Timing



Signal	Symbol	Parameter	Min	Max	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5	ms
			-	120	ms

4.2 MIPI Interface Characteristics:

High Speed Mode



DSI clock channel timing

Rising and falling time on clock and data channel

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-CLK+/-	$2xUI_{INSTA}$	Double UI instantaneous	4	25	ns	
DSI-CLK+/-	UI_{INSTA} UI_{INSTB}	UI instantaneous halves	2	12.5	ns	$UI = UI_{INSTA} = UI_{INSTB}$
DSI-Dn+/-	tDS	Data to clock setup time	0.15	-	UI	
DSI-Dn+/-	tDH	Data to clock hold time	0.15	-	UI	

5 Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply Voltage (Analog)	VDD~GND	-0.3	+4.6	V
Logic signal voltage(I/O)	IOVDD~GND	-0.3	+4.6	V
Operating Temperature	TOP	-20	70	° C
Storage Temperature	TST	-30	80	° C
Humidity	RH	-	90%(Max 60° C)	RH

6 Electrical Characteristics

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Analog operating voltage	VDD	2.5	2.8	3.6	V
Logic operating voltage	IOVDD	1.65	1.8	VDD	V
Input Current	IDD	-	TBD	-	mA
Input Voltage ' H ' level	VIH	0.7IOVCC	-	IOVCC	V
Input Voltage ' L ' level	VIL	GND	-	0.3IOVCC	
Output Voltage ' H ' level	VOH	0.8IOVCC	-	IOVCC	
Output Voltage ' L ' level	VOL	GND	-	0.2IOVCC	

7 Backlight Characteristics

ITEM	SYMBOL	MIN	TYP	MAX	UNIT
Voltage for LED backlight	V _f	-	12.4	13.2	V
Current for LED backlight	I _f	-	30	40	mA
Power consumption	W _{bl}	-	372	512	mW
Uniformity	Avg	80	-	-	%
LED Life Time	-	30000	40000	-	Hrs

Note:

1. The LED life time is defined as the module brightness decrease to 50% original brightness at Ta=25°C, 60%RH ±5 %.
2. The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions.
3. Typical operating life time is an estimated data.
4. Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is loaded .Functional operation should be restricted to the conditions described under normal operating conditions.

8 LCD Optical specifications

Item	Symbol	Condition	Specification			Unit	Remark
			Min	Typ	Max		
Response time (By Quick)	Tr+Tf	$\theta = 0^\circ$	-	25	40	ms	Note 5
Contrast ratio	CR	$\theta = 0^\circ$	-	700	-		Note 2,6
Viewing angle	Top	$CR \geq 10$	60	70	-	Deg.	Note 2,6,7
	Bottom	$CR \geq 10$	40	60	-		
	Left	$CR \geq 10$	60	70	-		
	Right	$CR \geq 10$	60	70	-		
Color chromaticity (CF only with ITO, light source is C light, CIE 1931)	Wx	$\theta = 0^\circ$	-0.3	0.308	+0.3		Note 3
	Wy		-0.3	0.328	+0.3		
	Rx		-0.3	0.608	+0.3		
	Ry		-0.3	0.330	+0.3		
	Gx		-0.3	0.302	+0.3		
	Gy		-0.3	0.565	+0.3		
	Bx		-0.3	0.144	+0.3		
	By		-0.3	0.111	+0.3		
Transmittance	Trans		-	4%	-	Note 4	

Note 1: Ambient temperature = 25°C.

Note 2: To be measured with a viewing cone of 2° by Topcon luminance meter BM-5A.

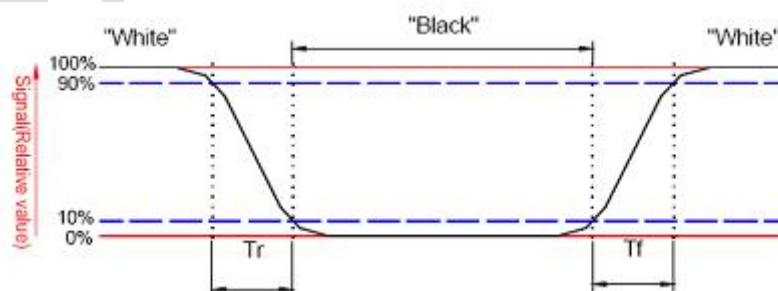
Note 3: To be measured with Otsuta chromaticity meter LCF-2100M, CF only measure under C light simulation.

Note 4: CTC shipping status is cell without polarizer. Transmittance of Specification is cell with polarizer.

The tolerance of Transmittance is ±10%.

Note 5: Definition of response time:

The output signals of TRD-100 are measured when the input signals are changed to “White” (falling time) and from “White” to “Black” (rising time), respectively. The interval is between the 10% and 90% of amplitudes. Refer to figure as below.

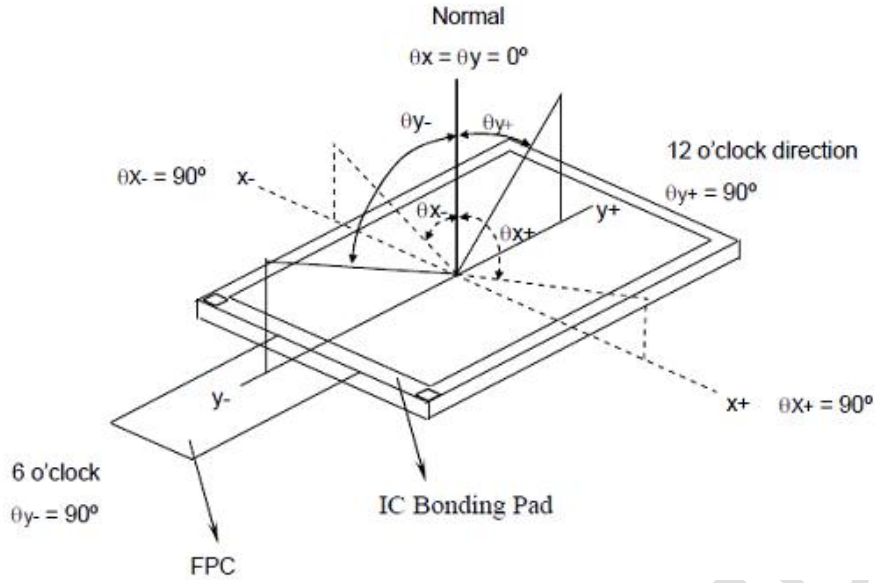


Note 6: Definition of contrast ratio:

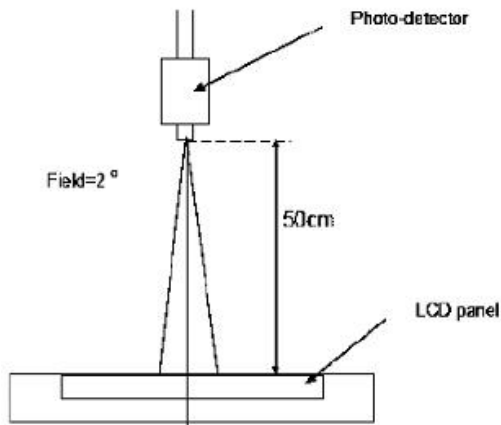
Contrast ratio is calculated by the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "white" state}}{\text{Brightness on the "black" state}}$$

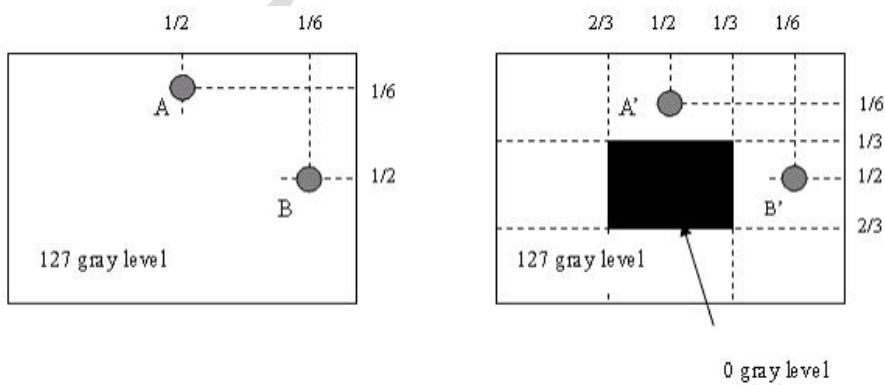
Note 7: Definition of viewing angle



Note 8: Optical characteristic measurement setup.



Note 9:



$1 \frac{LA-LA'}{LA} \times 100\% = 2\% \text{ max.}$, LA and LA' are brightness at location A and A'.

$1 \frac{LB-LB'}{LB} \times 100\% = 2\% \text{ max.}$, LB and LB' are brightness at location B and B'.

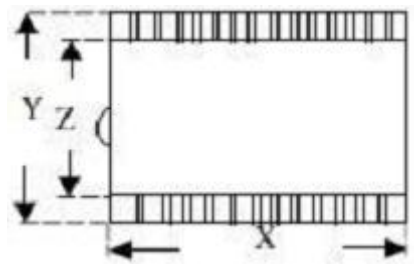
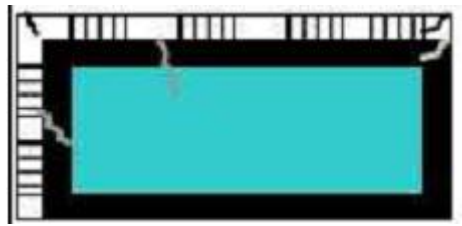
9 RELIABILITY TEST

NO.	TEST ITEM	TEST CONDITION	INSPECTION AFTER TEST
1	High Temperature Storage	80±2°C/96 hours	Inspection after 2~4 hours storage at room temperature and humidity. The condensation is not accepted. The sample shall be free from defects: 1. Air bubble in the LCD 2. Seal leak 3. Non-display 4. Missing segments 5. Glass crack
2	Low Temperature Storage	-30±2°C/96 hours	
3	High Temperature Operating	70±2°C/96 hours	
4	Low Temperature Operating	-15±2°C/96 hours	
5	Temperature Cycle	-30±2°C ~ 25~ 80± 2°C × 10 cycles (30 min.) (5min.) (30min.)	
6	Damp Proof Test	60°C ±5°C × 90%RH/96 hours	
7	Vibration Test	Frequency 10Hz~55Hz Stroke: 1.5mm Sweep: 10Hz~150 Hz~10Hz 2 hours For each direction of X, Y, Z	
8	Shock Test	Half-sine, wave, 300m/s	
9	Packing Drop Test	Height: 80 cm 1 corner, concrete floor	
10	Electrostatic Discharge Test	C=150pF, R=330 Ω Air: ±8KV 150pF/330Ω 30 times Contact: ±4KV,20 times	

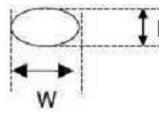
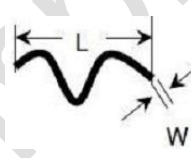
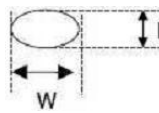
10 Inspection standards

10.1 Visual inspection criterion in cosmetic

10.1.1 Glass defect

NO.	Defect	Criteria	Remark
1	Dimension(Minor)	By engineering diagram	
2	Cracks(Major)	Extensive crack [Reject]	

10.1.2 LCM appearance defect

NO.	Defect	Criteria		Remark
		Spec	Permissible Qty	
1	Round type(Minor)	$\phi \leq 0.1\text{mm}$	Disregard	1. $\phi = (W+L)/2$, L:Length,W=Width 2.Disregard if out of A.A 
		$0.1\text{mm} < \phi \leq 0.2\text{mm}$	2	
		$\phi > 0.2\text{mm}$	0	
2	Line type(Minor)	$W \leq 0.03\text{mm}$	Disregard	1. L:Length,W=Width 2.Disregard if out of A.A 
		$L \leq 3.0\text{mm}$ and $0.03\text{mm} < W \leq 0.05\text{mm}$	2	
		$L \leq 3.0\text{mm}$ and $0.05\text{mm} < W \leq 0.1\text{mm}$	1	
		$W > 0.10\text{mm}$ or $L > 3.0\text{mm}$	0	
3	Polarizer dent(Minor)	$\phi \leq 0.2\text{mm}$	Disregard	1. $\phi = (W+L)/2$, L:Length,W=Width 2.Disregard if out of A.A 
		$0.2\text{mm} < \phi \leq 0.3\text{mm}$	2	
		$0.3\text{mm} < \phi \leq 0.5\text{mm}$	1	
		$\phi > 0.5\text{mm}$	0	

10.1.3 FPC

NO.	Defect	Criteria	Remark
1	Copper peeling(Minor)	Copper peeling [Reject]	
2	Damaged	Damaged[Reject]	

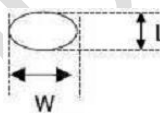
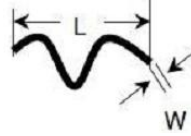
10.1.4 Black tape

NO.	Defect	Criteria	Remark
1	Shift(Minor)	IC exposed [Reject]	
2	No black tape(Minor)	No black tape [Reject]	

10.1.5 Silicon

NO.	Defect	Criteria	Remark
1	Amount of silicon (Minor)	ITO exposed [Reject]	

10.2 Visual inspection criterion in electrical display

NO.	Defect	Criteria		Remark
		Spec.	Permissible Qty	
1	No display (Major)	Not allowed		
2	Missing line (Major)	Not allowed		
3	Darker or lighter Line (Major)	Not allowed		
4	Weak line(Major)	By limited sample		
5	Bright / Dark point (Minor)	Bright point	1	1:1 sub-pixel: 1R or 1G or 1B 2:Point defect area 1/2 sub pixel.
		Dark point	2	
6	Round type (Minor)	$\phi \leq 0.1\text{mm}$	Disregard	1. $\phi = (W+L)/2$, L:Length,W=Width 2.Disregard if out of A.A 
		$0.1 < \phi \leq 0.2$	3	
		$\phi > 0.2\text{mm}$	0	
	Line type (Minor)	$W \leq 0.03\text{mm}$	Disregard	1. L:Length,W=Width 2.Disregard if out of A.A 
		$L \leq 3.0\text{mm}$ and $0.03\text{mm} < W \leq 0.05\text{mm}$	2	
		$L \leq 3.0\text{mm}$ and $0.05\text{mm} < W \leq 0.1\text{mm}$	1	
		$W > 0.10\text{mm}$ or $L > 3.0\text{mm}$	0	
	Mura (Minor)	By 5% ND filter invisible		

10.3 Others

1. Issues that are not defined in this document shall be discussed and agreed with both parties. (Customer and supplier)
2. Unless otherwise agreed upon in writing, the criteria shall be applied to both parties. (Customer and supplier)

11 Suggestions for using LCD modules

11.1 Handling of LCM

1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
3. Don't apply excessive force on the surface of the LCM.
4. If the surface is contaminated, clean it with soft cloth. If the LCM is severely contaminated, use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer. The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
7. Don't disassemble the LCM.
8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
9. Do not alter, modify or change the the shape of the tab on the metal frame.
10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
11. Do not damage or modify the pattern writing on the printed circuit board.
12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
14. Do not drop, bend or twist LCM.

11.2 Storage

1. Store in an ambient temperature of 5 to 45 C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
2. Storage in a clean environment, free from dust, active gas, and solvent.
3. Store in antistatic container.

